

Title (en)

METHOD OF INSTALLING HEAT SOURCE, AND MICRO HEAT PIPE MODULE

Title (de)

VERFAHREN ZUR INSTALLATION EINER WÄRMEQUELLE UND EINES WÄRMEROHR-MODULES

Title (fr)

PROCEDE D'INSTALLATION DE SOURCE THERMIQUE ET MODULE A MICROCALODUCS

Publication

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Application

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Abstract (en)

[origin: WO0103484A1] The invention relates to a method of installing a heat source generating thermal energy on a micro heat pipe module and to a micro heat pipe module. The micro heat pipe module (1) has micro heat pipes (3) for dissipating the thermal energy generated by the heat source (2) generating thermal energy, and the micro heat pipe module (1) has a side (4) on which the heat source (2) generating thermal energy is installed. The side (4) of the micro heat pipe module (1), on which the heat source (2) generating thermal energy is installed, is at least partly coated with a coating (5) made of a heat conducting material, which coating (5) is arranged to conduct the heat generated by the heat source (2) generating thermal energy away from the heat source (2) generating thermal energy along said side (4) of the micro heat pipe module (1) and to the micro heat pipe module (1).

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